



**SLOVENSKI STANDARD**  
**SIST EN 61191-2:2018/AC:2020**

**01-julij-2020**

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**Sestavi plošč tiskanih vezij - 2. del: Področna specifikacija - Zahteve za površinsko nameščene spajkane sestave - Popravek AC**

Printed board assemblies - Part 2: Sectional specification - Requirements for surface mount soldered assemblies

Elektronikaufbauten auf Leiterplatten - Teil 2: Rahmenspezifikation - Anforderungen an gelötete Baugruppen in Oberflächenmontage

Ensembles de cartes imprimées - Partie 2: Spécification intermédiaire - Exigences relatives à l'assemblage par brasage pour montage en surface

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**Ta slovenski standard je istoveten z: EN 61191-2:2017/AC:2019-10**

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**ICS:**

31.180 Tiskana vezja (TIV) in tiskane Printed circuits and boards plošče

31.190 Sestavljeni elektronski elementi Electronic component assemblies

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EUROPEAN STANDARD  
NORME EUROPÉENNE  
EUROPÄISCHE NORM

**EN 61191-2:2017/AC:2019-10**

October 2019

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ICS 31.190; 31.240

English Version

**Printed board assemblies - Part 2: Sectional specification -  
Requirements for surface mount soldered assemblies  
(IEC 61191-2:2017/COR1:2019)**

Ensembles de cartes imprimées - Partie 2: Spécification  
intermédiaire - Exigences relatives à l'assemblage par  
brasage pour montage en surface  
(IEC 61191-2:2017/COR1:2019)

Elektronikaufbauten auf Leiterplatten - Teil 2:  
Rahmenspezifikation - Anforderungen an gelötete  
Baugruppen in Oberflächenmontage  
(IEC 61191-2:2017/COR1:2019)

This corrigendum becomes effective on 25 October 2019 for incorporation in the English language version of the EN.

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European Committee for Electrotechnical Standardization  
Comité Européen de Normalisation Electrotechnique  
Europäisches Komitee für Elektrotechnische Normung

**CEN-CENELEC Management Centre: Rue de la Science 23, B-1040 Brussels**

### Endorsement notice

The text of the corrigendum IEC 61191-2:2017/COR1:2019 was approved by CENELEC as EN 61191-2:2017/AC:2019-10 without any modification.

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

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**IEC 61191-2**  
Edition 3.0 2017-05

**PRINTED BOARD ASSEMBLIES –**  
**Part 2: Sectional specification –**  
**Requirements for surface mount soldered assemblies**

**C O R R I G E N D U M 1**

**Figure 5 – J lead joint**

*Replace, in the table, footnote f by footnote d, and delete footnote e.*

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